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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	33
Program Memory Size	16KB (8K x 16)
Program Memory Type	EPROM, UV
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	40-CDIP (0.600", 15.24mm) Window
Supplier Device Package	40-Cerdip
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18c442-jw

TABLE 1-3: PIC18C4X2 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	DIP	PLCC	TQFP			
						PORTC is a bi-directional I/O port.
RC0/T1OSO/T1CKI	15	16	32			
RC0				I/O	ST	Digital I/O.
T1OSO				O	—	Timer1 oscillator output.
T1CKI				I	ST	Timer1/Timer3 external clock input.
RC1/T1OSI/CCP2	16	18	35			
RC1				I/O	ST	Digital I/O.
T1OSI				I	CMOS	Timer1 oscillator input.
CCP2				I/O	ST	Capture2 input, Compare2 output, PWM2 output.
RC2/CCP1	17	19	36			
RC2				I/O	ST	Digital I/O.
CCP1				I/O	ST	Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	18	20	37			
RC3				I/O	ST	Digital I/O.
SCK				I/O	ST	Synchronous serial clock input/output for SPI mode.
SCL				I/O	ST	Synchronous serial clock input/output for I^2C mode.
RC4/SDI/SDA	23	25	42			
RC4				I/O	ST	Digital I/O.
SDI				I	ST	SPI Data In.
SDA				I/O	ST	I^2C Data I/O.
RC5/SDO	24	26	43			
RC5				I/O	ST	Digital I/O.
SDO				O	—	SPI Data Out.
RC6/TX/CK	25	27	44			
RC6				I/O	ST	Digital I/O.
TX				O	—	USART Asynchronous Transmit.
CK				I/O	ST	USART Synchronous Clock (see related RX/DT).
RC7/RX/DT	26	29	1			
RC7				I/O	ST	Digital I/O.
RX				I	ST	USART Asynchronous Receive.
DT				I/O	ST	USART Synchronous Data (see related TX/CK).

Legend: TTL = TTL compatible input
CMOS = CMOS compatible input or output
ST = Schmitt Trigger input with CMOS levels
I = Input
O = Output
P = Power
OD = Open Drain (no P diode to V_{DD})

TABLE 3-1: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	Power-up(2)		Brown-out(2)	Wake-up from SLEEP or Oscillator Switch
	$\overline{PWRTE}$ = 0	$\overline{PWRTE}$ = 1		
HS with PLL enabled(1)	72 ms + 1024TOSC + 2ms	1024TOSC + 2 ms	72 ms + 1024TOSC + 2ms	1024TOSC + 2 ms
HS, XT, LP	72 ms + 1024TOSC	1024TOSC	72 ms + 1024TOSC	1024TOSC
EC	72 ms	—	72 ms	—
External RC	72 ms	—	72 ms	—

Note 1: 2 ms is the nominal time required for the 4x PLL to lock.
2: 72 ms is the nominal Power-up Timer delay.

REGISTER 3-1: RCON REGISTER BITS AND POSITIONS

R/W-0	R/W-0	U-0	R/W-1	R/W-1	R/W-1	R/W-0	R/W-0
IPEN	LWRT	—	$\overline{RI}$	$\overline{TO}$	$\overline{PD}$	$\overline{POR}$	$\overline{BOR}$
bit 7							bit 0

Note: See Register 4-3 on page 53 for bit definitions.

TABLE 3-2: STATUS BITS, THEIR SIGNIFICANCE AND THE INITIALIZATION CONDITION FOR RCON REGISTER

Condition	Program Counter	RCON Register	RI	TO	PD	POR	BOR	STKFUL	STKUNF
Power-on Reset	0000h	00-1 1100	1	1	1	0	0	u	u
$\overline{MCLR}$ Reset during normal operation	0000h	00-u uuuu	u	u	u	u	u	u	u
Software Reset during normal operation	0000h	0u-0 uuuu	0	u	u	u	u	u	u
Stack Full Reset during normal operation	0000h	0u-u uu11	u	u	u	u	u	u	1
Stack Underflow Reset during normal operation	0000h	0u-u uu11	u	u	u	u	u	1	u
$\overline{MCLR}$ Reset during SLEEP	0000h	00-u 10uu	u	1	0	u	u	u	u
WDT Reset	0000h	0u-u 01uu	1	0	1	u	u	u	u
WDT Wake-up	PC + 2	uu-u 00uu	u	0	0	u	u	u	u
Brown-out Reset	0000h	0u-1 11u0	1	1	1	1	0	u	u
Interrupt wake-up from SLEEP	PC + 2(1)	uu-u 00uu	u	1	0	u	u	u	u

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0'.
Note 1: When the wake-up is due to an interrupt and the GIEH or GIEL bits are set, the PC is loaded with the interrupt vector (0x000008h or 0x000018h).

4.3 Fast Register Stack

A "fast interrupt return" option is available for interrupts. A Fast Register Stack is provided for the STATUS, WREG and BSR registers and are only one in depth. The stack is not readable or writable and is loaded with the current value of the corresponding register when the processor vectors for an interrupt. The values in the registers are then loaded back into the working registers, if the `FAST RETURN` instruction is used to return from the interrupt.

A low or high priority interrupt source will push values into the stack registers. If both low and high priority interrupts are enabled, the stack registers cannot be used reliably for low priority interrupts. If a high priority interrupt occurs while servicing a low priority interrupt, the stack register values stored by the low priority interrupt will be overwritten.

If high priority interrupts are not disabled during low priority interrupts, users must save the key registers in software during a low priority interrupt.

If no interrupts are used, the fast register stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the fast register stack for a subroutine call, a `FAST CALL` instruction must be executed.

Example 4-1 shows a source code example that uses the fast register stack.

EXAMPLE 4-1: FAST REGISTER STACK CODE EXAMPLE

```
CALL SUB1, FAST    ;STATUS, WREG, BSR
                   ;SAVED IN FAST REGISTER
                   ;STACK
       •
       •

SUB1   •
       •
       •
   RETURN FAST     ;RESTORE VALUES SAVED
                   ;IN FAST REGISTER STACK
```

4.4 PCL, PCLATH and PCLATU

The program counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21-bits wide. The low byte is called the PCL register. This register is readable and writable. The high byte is called the PCH register. This register contains the PC<15:8> bits and is not directly readable or writable. Updates to the PCH register may be performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits and is not directly readable or writable. Updates to the PCU register may be performed through the PCLATU register.

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the LSB of PCL is fixed to a value of ’0’. The PC increments by 2 to address sequential instructions in the program memory.

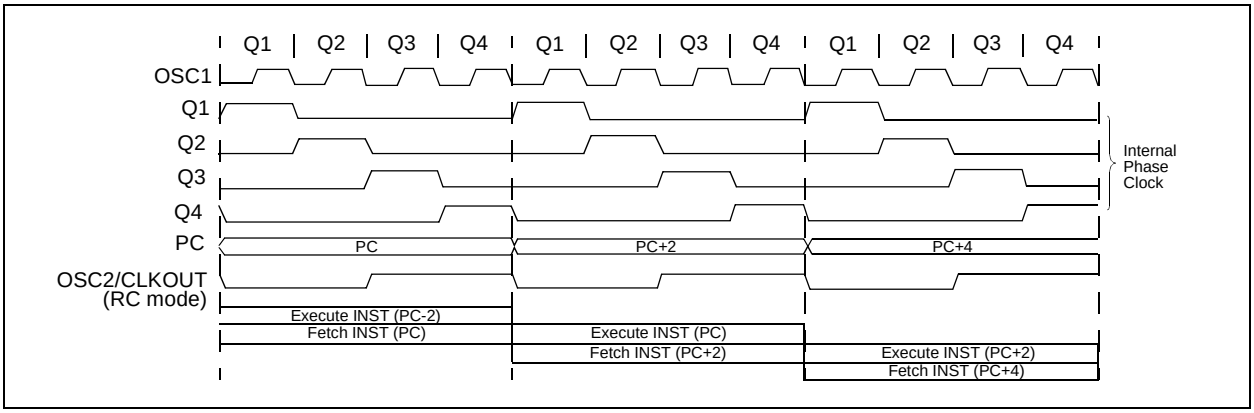
The `CALL, RCALL, GOTO` and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

The contents of PCLATH and PCLATU will be transferred to the program counter by an operation that writes PCL. Similarly, the upper two bytes of the program counter will be transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see Section 4.8.1).

4.5 Clocking Scheme/Instruction Cycle

The clock input (from OSC1) is internally divided by four to generate four non-overlapping quadrature clocks, namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 4-4.

FIGURE 4-4: CLOCK/INSTRUCTION CYCLE



5.1.2 TABLAT - TABLE LATCH REGISTER

The Table Latch (TABLAT) is an 8-bit register mapped into the SFR space. The Table Latch is used to hold 8-bit data during data transfers between program memory and data memory.

5.1.3 TBLPTR - TABLE POINTER REGISTER

The Table Pointer (TBLPTR) addresses a byte within the program memory. The TBLPTR is comprised of three SFR registers (Table Pointer Upper Byte, High Byte and Low Byte). These three registers (TBLPTRU:TBLPTRH:TBLPTRL) join to form a 22-bit wide pointer. The lower 21-bits allow the device to address up to 2 Mbytes of program memory space. The 22nd bit allows access to the Device ID, the User ID and the Configuration bits.

The Table Pointer, TBLPTR, is used by the `TBLRD` and `TBLWT` instructions. These instructions can update the TBLPTR in one of four ways, based on the table operation. These operations are shown in Table 5-1. These operations on the TBLPTR only affect the lower 21-bits.

TABLE 5-1: TABLE POINTER OPERATIONS WITH `TBLRD` AND `TBLWT` INSTRUCTIONS

Example	Operation on Table Pointer
`TBLRD*` `TBLWT*`	TBLPTR is not modified
`TBLRD*+` `TBLWT*+`	TBLPTR is incremented after the read/write
`TBLRD*-` `TBLWT*-`	TBLPTR is decremented after the read/write
`TBLRD+*` `TBLWT+*`	TBLPTR is incremented before the read/write

5.2 Internal Program Memory Read/ Writes

5.2.1 TABLE READ OVERVIEW (`TBLRD`)

The `TBLRD` instructions are used to read data from program memory to data memory.

TBLPTR points to a byte address in program space. Executing `TBLRD` places the byte pointed to into TABLAT. In addition, TBLPTR can be modified automatically for the next Table Read operation.

Table Reads from program memory are performed one byte at a time. The instruction will load TABLAT with the one byte from program memory pointed to by TBLPTR.

5.2.2 INTERNAL PROGRAM MEMORY WRITE BLOCK SIZE

The internal program memory of PIC18CXXX devices is written in blocks. For PIC18CXX2 devices, the write block size is 2 bytes. Consequently, Table Write operations to internal program memory are performed in pairs, one byte at a time.

When a Table Write occurs to an even program memory address (TBLPTR<0> = 0), the contents of TABLAT are transferred to an internal holding register. This is performed as a short write and the program memory block is not actually programmed at this time. The holding register is not accessible by the user.

When a Table Write occurs to an odd program memory address (TBLPTR<0>=1), a long write is started. During the long write, the contents of TABLAT are written to the high byte of the program memory block and the contents of the holding register are transferred to the low byte of the program memory block.

Figure 5-3 shows the holding register and the program memory write blocks.

If a single byte is to be programmed, the low (even) byte of the destination program word should be read using `TBLRD*`, modified or changed, if required, and written back to the same address using `TBLWT*+`. The high (odd) byte should be read using `TBLRD*`, modified or changed if required, and written back to the same address using `TBLWT`. A write to the odd address will cause a long write to begin. This process ensures that existing data in either byte will not be changed unless desired.

7.1 INTCON Registers

The INTCON Registers are readable and writable registers, which contains various enable, priority, and flag bits.

REGISTER 7-1: INTCON REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF
bit 7							bit 0

bit 7 **GIE/GIEH:** Global Interrupt Enable bit
When IPEN = 0:
1 = Enables all unmasked interrupts
0 = Disables all interrupts
When IPEN = 1:
1 = Enables all high priority interrupts
0 = Disables all high priority interrupts

bit 6 **PEIE/GIEL:** Peripheral Interrupt Enable bit
When IPEN = 0:
1 = Enables all unmasked peripheral interrupts
0 = Disables all peripheral interrupts
When IPEN = 1:
1 = Enables all low priority peripheral interrupts
0 = Disables all low priority peripheral interrupts

bit 5 **TMR0IE:** TMR0 Overflow Interrupt Enable bit
1 = Enables the TMR0 overflow interrupt
0 = Disables the TMR0 overflow interrupt

bit 4 **INT0IE:** INT0 External Interrupt Enable bit
1 = Enables the INT0 external interrupt
0 = Disables the INT0 external interrupt

bit 3 **RBIE:** RB Port Change Interrupt Enable bit
1 = Enables the RB port change interrupt
0 = Disables the RB port change interrupt

bit 2 **TMR0IF:** TMR0 Overflow Interrupt Flag bit
1 = TMR0 register has overflowed (must be cleared in software)
0 = TMR0 register did not overflow

bit 1 **INT0IF:** INT0 External Interrupt Flag bit
1 = The INT0 external interrupt occurred (must be cleared in software)
0 = The INT0 external interrupt did not occur

bit 0 **RBIF:** RB Port Change Interrupt Flag bit
1 = At least one of the RB7:RB4 pins changed state (must be cleared in software)
0 = None of the RB7:RB4 pins have changed state

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR reset	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit, or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 7-3: INTCON3 REGISTER

R/W-1	R/W-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
INT2IP	INT1IP	—	INT2IE	INT1IE	—	INT2IF	INT1IF
bit 7							bit 0

bit 7 **INT2IP:** INT2 External Interrupt Priority bit
1 = High priority
0 = Low priority

bit 6 **INT1IP:** INT1 External Interrupt Priority bit
1 = High priority
0 = Low priority

bit 5 **Unimplemented:** Read as '0'

bit 4 **INT2IE:** INT2 External Interrupt Enable bit
1 = Enables the INT2 external interrupt
0 = Disables the INT2 external interrupt

bit 3 **INT1IE:** INT1 External Interrupt Enable bit
1 = Enables the INT1 external interrupt
0 = Disables the INT1 external interrupt

bit 2 **Unimplemented:** Read as '0'

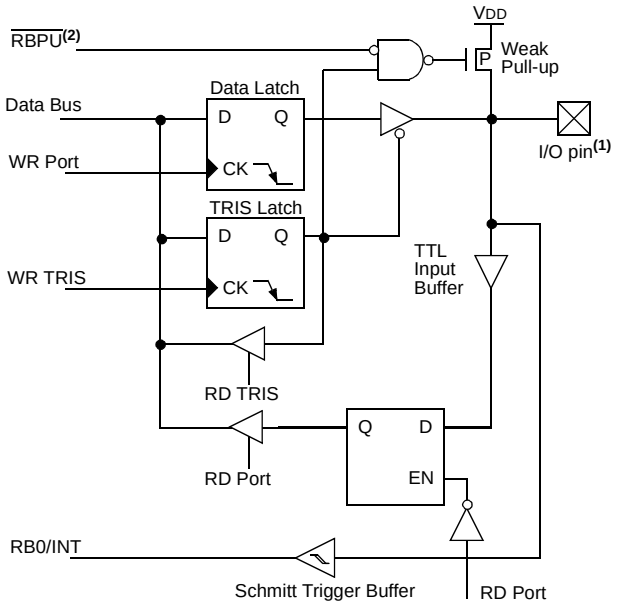
bit 1 **INT2IF:** INT2 External Interrupt Flag bit
1 = The INT2 external interrupt occurred (must be cleared in software)
0 = The INT2 external interrupt did not occur

bit 0 **INT1IF:** INT1 External Interrupt Flag bit
1 = The INT1 external interrupt occurred (must be cleared in software)
0 = The INT1 external interrupt did not occur

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR reset	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

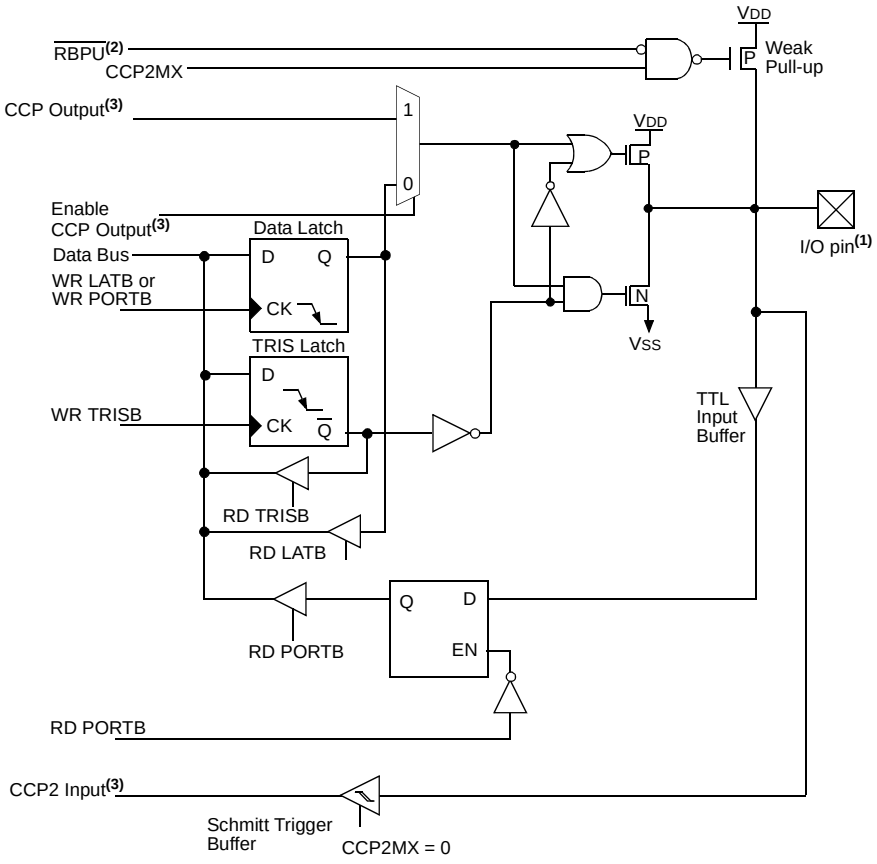
Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit, or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

FIGURE 8-5: BLOCK DIAGRAM OF RB2:RB0 PINS



Note 1: I/O pins have diode protection to VDD and VSS.
2: To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the $\overline{\text{RBPU}}$ bit (OPTION_REG<7>).

FIGURE 8-6: BLOCK DIAGRAM OF RB3



Note 1: I/O pin has diode protection to VDD and VSS.
2: To enable weak pull-ups, set the appropriate DDR bit(s) and clear the $\overline{\text{RBPU}}$ bit (INTCON2<7>).
3: The CCP2 input/output is multiplexed with RB3, if the CCP2MX bit is enabled (='0') in the configuration register.

14.3 SPI Mode

The SPI mode allows 8-bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO) - RC5/SDO
- Serial Data In (SDI) - RC4/SDI/SDA
- Serial Clock (SCK) - RC3/SCK/SCL/LVOIN

Additionally, a fourth pin may be used when in a Slave mode of operation:

- Slave Select ($\overline{SS}$) - RA5/$\overline{SS}$/AN4

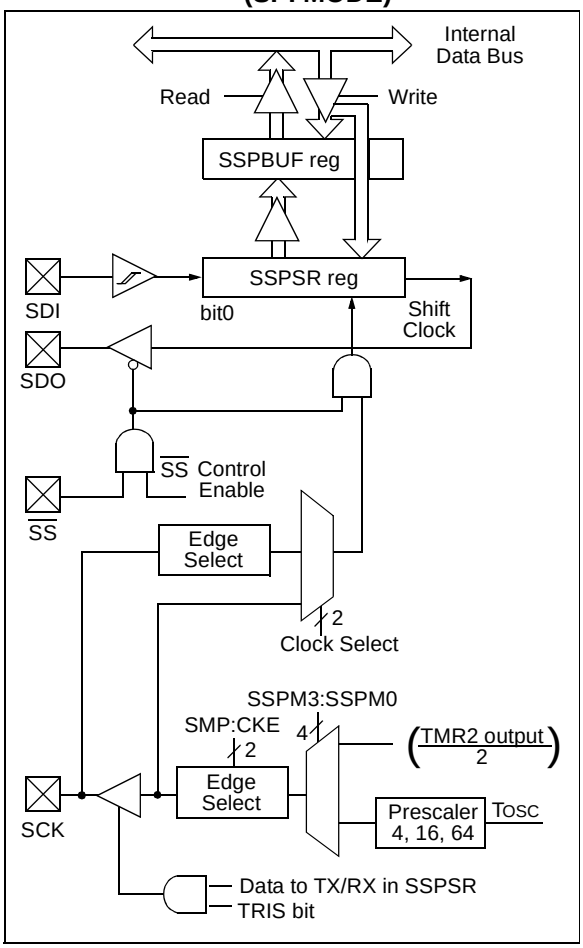
14.3.1 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPCON1<5:0>) and SSPSTAT<7:6>. These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- Slave mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data input sample phase (middle or end of data output time)
- Clock edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

Figure 14-1 shows the block diagram of the MSSP module, when in SPI mode.

FIGURE 14-1: MSSP BLOCK DIAGRAM (SPI MODE)



The MSSP consists of a transmit/receive shift register (SSPSR) and a buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR, until the received data is ready. Once the 8-bits of data have been received, that byte is moved to the SSPBUF register. Then the buffer full detect bit, BF (SSPSTAT<0>), and the interrupt flag bit, SSPIF, are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit, WCOL (SSPCON1<7>), will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully.

14.4.7 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated START condition occurs when the RSEN bit (SSPCON2<1>) is programmed high and the I²C logic module is in the idle state. When the RSEN bit is set, the SCL pin is asserted low. When the SCL pin is sampled low, the baud rate generator is loaded with the contents of SSPADD<5:0> and begins counting. The SDA pin is released (brought high) for one baud rate generator count (T_{BRG}). When the baud rate generator times out, if SDA is sampled high, the SCL pin will be de-asserted (brought high). When SCL is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. SDA and SCL must be sampled high for one TBRG. This action is then followed by assertion of the SDA pin (SDA = 0) for one TBRG, while SCL is high. Following this, the RSEN bit (SSPCON2<1>) will be automatically cleared and the baud rate generator will not be reloaded, leaving the SDA pin held low. As soon as a START condition is detected on the SDA and SCL pins, the S bit (SSPSTAT<3>) will be set. The SSPIF bit will not be set until the baud rate generator has timed out.

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

2: A bus collision during the Repeated START condition occurs if:

- SDA is sampled low when SCL goes from low to high.
- SCL goes low before SDA is asserted low. This may indicate that another master is attempting to transmit a data "1".

Immediately following the SSPIF bit getting set, the user may write the SSPBUF with the 7-bit address in 7-bit mode, or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode), or eight bits of data (7-bit mode).

14.4.7.1 WCOL Status Flag

If the user writes the SSPBUF when a Repeated START sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPCON2 is disabled until the Repeated START condition is complete.

FIGURE 14-17: REPEAT START CONDITION WAVEFORM

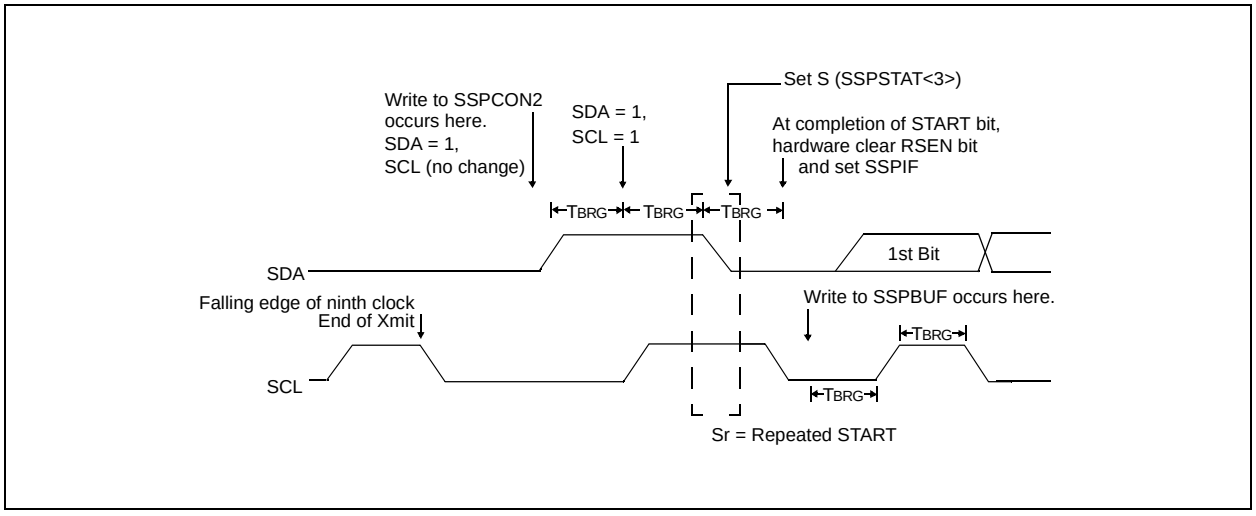
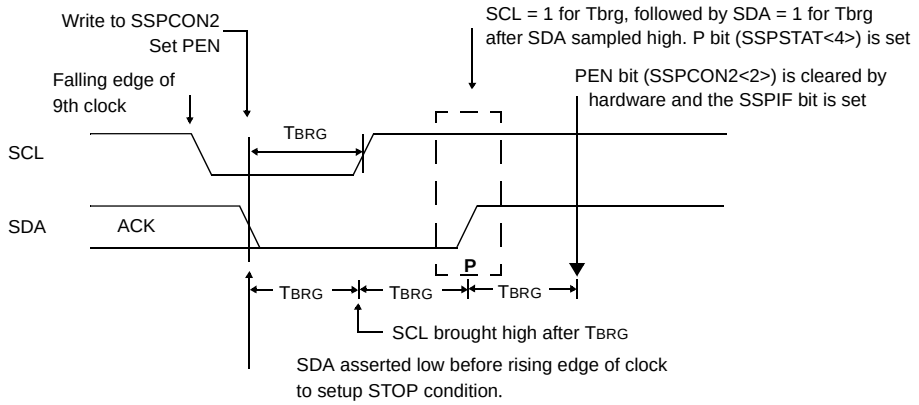


FIGURE 14-21: STOP CONDITION RECEIVE OR TRANSMIT MODE



Note: TBRG = one baud rate generator period.

14.4.12 CLOCK ARBITRATION

Clock arbitration occurs when the master, during any receive, transmit, or Repeated START/STOP condition, de-asserts the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the baud rate generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count, in the event that the clock is held low by an external device (Figure 14-22).

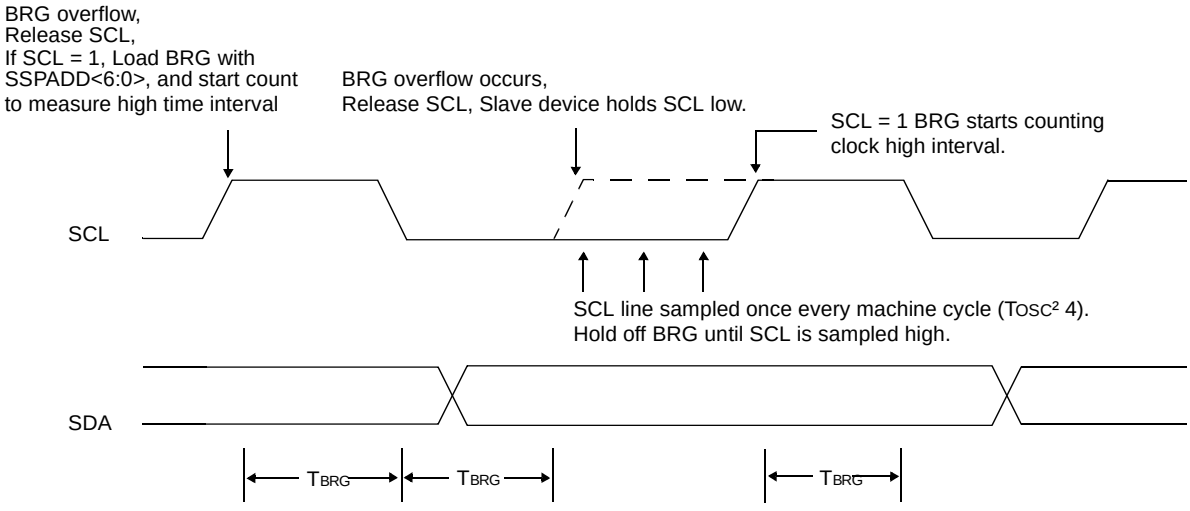
14.4.13 SLEEP OPERATION

While in SLEEP mode, the I^2C module can receive addresses or data, and when an address match or complete byte transfer occurs, wake the processor from SLEEP (if the MSSP interrupt is enabled).

14.4.14 EFFECT OF A RESET

A RESET disables the MSSP module and terminates the current transfer.

FIGURE 14-22: CLOCK ARBITRATION TIMING IN MASTER TRANSMIT MODE



REGISTER 18-3: CONFIGURATION REGISTER 2 HIGH (CONFIG2H: BYTE ADDRESS 300003h)

U-0	U-0	U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
—	—	—	—	WDTPS2	WDTPS1	WDTPS0	WDTEN
bit 7							bit 0

bit 7-4 **Unimplemented:** Read as '0'

bit 3-1 **WDTPS2:WDTPS0:** Watchdog Timer Postscale Select bits
111 = 1:1
110 = 1:2
101 = 1:4
100 = 1:8
011 = 1:16
010 = 1:32
001 = 1:64
000 = 1:128

bit 0 **WDTEN:** Watchdog Timer Enable bit
1 = WDT enabled
0 = WDT disabled (control is placed on the SWDTEN bit)

Legend:		
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'
- n = Value when device is unprogrammed		u = Unchanged from programmed state

REGISTER 18-4: CONFIGURATION REGISTER 2 LOW (CONFIG2L: BYTE ADDRESS 300002h)

U-0	U-0	U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
—	—	—	—	BORV1	BORV0	BOREN	$\overline{\text{PWRTEN}}$
bit 7							bit 0

bit 7-4 **Unimplemented:** Read as '0'

bit 3-2 **BORV1:BORV0:** Brown-out Reset Voltage bits
11 = V_{BOR} set to 2.5V
10 = V_{BOR} set to 2.7V
01 = V_{BOR} set to 4.2V
00 = V_{BOR} set to 4.5V

bit 1 **BOREN:** Brown-out Reset Enable bit(1)
1 = Brown-out Reset enabled
0 = Brown-out Reset disabled

Note: Enabling Brown-out Reset automatically enables the Power-up Timer (PWRT), regardless of the value of bit $\overline{\text{PWRTEN}}$. Ensure the Power-up Timer is enabled any time Brown-out Reset is enabled.

bit 0 **$\overline{\text{PWRTEN}}$:** Power-up Timer Enable bit(1)
1 = PWRT disabled
0 = PWRT enabled

Note: Enabling Brown-out Reset automatically enables the Power-up Timer (PWRT), regardless of the value of bit $\overline{\text{PWRTE}}$. Ensure the Power-up Timer is enabled any time Brown-out Reset is enabled.

Legend:		
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'
- n = Value when device is unprogrammed		u = Unchanged from programmed state

18.2 Watchdog Timer (WDT)

The Watchdog Timer is a free running, on-chip RC oscillator, which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKI pin. That means that the WDT will run, even if the clock on the OSC1/CLKI and OSC2/CLKO/RA6 pins of the device has been stopped, for example, by execution of a SLEEP instruction.

During normal operation, a WDT time-out generates a device RESET (Watchdog Timer Reset). If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation (Watchdog Timer Wake-up). The $\overline{TO}$ bit in the RCON register will be cleared upon a WDT time-out.

The Watchdog Timer is enabled/disabled by a device configuration bit. If the WDT is enabled, software execution may not disable this function. When the WDTEN configuration bit is cleared, the SWDTEN bit enables/disables the operation of the WDT.

The WDT time-out period values may be found in the Electrical Specifications section under parameter #31. Values for the WDT postscaler may be assigned using the configuration bits.

Note:	The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET condition.

Note:	When a CLRWDT instruction is executed and the postscaler is assigned to the WDT, the postscaler count will be cleared, but the postscaler assignment is not changed.

18.2.1 CONTROL REGISTER

Register 18-7 shows the WDTCON register. This is a readable and writable register, which contains a control bit that allows software to override the WDT enable configuration bit, only when the configuration bit has disabled the WDT.

REGISTER 18-7: WDTCON REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	SWDTEN
bit 7							bit 0

bit 7-1 **Unimplemented**: Read as ’0’

bit 0 **SWDTEN:** Software Controlled Watchdog Timer Enable bit

1 = Watchdog Timer is on

0 = Watchdog Timer is turned off if the WDTEN configuration bit in the configuration register = ’0’

Legend:	
R = Readable bit	W = Writable bit
U = Unimplemented bit, read as ‘0’	- n = Value at POR Reset

BCF **Bit Clear f**

Syntax: [*label*] BCF f,b[,a]

Operands: $0 \le f \le 255$
$0 \le b \le 7$
$a \in [0,1]$

Operation: $0 \rightarrow f<b>$

Status Affected: None

Encoding:

1001	bbba	ffff	ffff

Description: Bit 'b' in register 'f' is cleared. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BCF FLAG_REG, 7, 0`

Before Instruction
`FLAG_REG = 0xC7`
After Instruction
`FLAG_REG = 0x47`

BN **Branch if Negative**

Syntax: [*label*] BN n

Operands: $-128 \le n \le 127$

Operation: if negative bit is '1'
$(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding:

1110	0110	nnnn	nnnn

Description: If the Negative bit is '1', then the program will branch.
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is then a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example:
```
HERE    BN   Jump
```
Before Instruction
```
PC          =   address (HERE)
```
After Instruction
```
If Negative =   1;
   PC       =   address (Jump)
If Negative =   0;
   PC       =   address (HERE+2)
```

TSTFSZ **Test f, skip if 0**

Syntax: [*label*] TSTFSZ f [,a]

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: skip if f = 0

Status Affected: None

Encoding:

0110	011a	ffff	ffff

Description: If 'f' = 0, the next instruction, fetched during the current instruction execution, is discarded and a NOP is executed, making this a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE    TSTFSZ  CNT, 1
NZERO     :
ZERO    :
```

Before Instruction
```
PC = Address(HERE)
```
After Instruction
```
If CNT      =   0x00,
   PC       =   Address (ZERO)
If CNT      ≠   0x00,
   PC       =   Address (NZERO)
```

XORLW **Exclusive OR literal with WREG**

Syntax: [*label*] XORLW k

Operands: $0 \le k \le 255$

Operation: (WREG) .XOR. k → WREG

Status Affected: N,Z

Encoding:

0000	1010	kkkk	kkkk

Description: The contents of WREG are XORed with the 8-bit literal 'k'. The result is placed in WREG.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to WREG

Example: XORLW 0xAF

Before Instruction
```
WREG    =   0xB5
```
After Instruction
```
WREG    =   0x1A
```

TABLE 21-2: EPROM PROGRAMMING REQUIREMENTS

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +40°C			
Param. No.	**Sym**	**Characteristic**	**Min**	**Max**	**Units**	**Conditions**
		Internal Program Memory Programming Specs (Note 1)				
D110	VPP	Voltage on MCLR/VPP pin	12.75	13.25	V	**(Note 2)**
D111	VDDP	Supply voltage during programming	4.75	5.25	V	
D112	IPP	Current into MCLR/VPP pin	—	50	mA	
D113	IDDP	Supply current during programming	—	30	mA	
D114	TPROG	Programming pulse width	50	1000	μs	Terminated via internal/external interrupt or a RESET
D115	TERASE	EPROM erase time				
		Device operation ≤ 3V	60	—	min.	
		Device operation ≥ 3V	30	—	min.	

Note 1: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in the PIC18CXXX Programming Specifications (Literature Number DS39028).

2: The MCLR/VPP pin may be kept in this range at times other than programming, but is not recommended.

FIGURE 21-15: EXAMPLE SPI SLAVE MODE TIMING (CKE = 1)

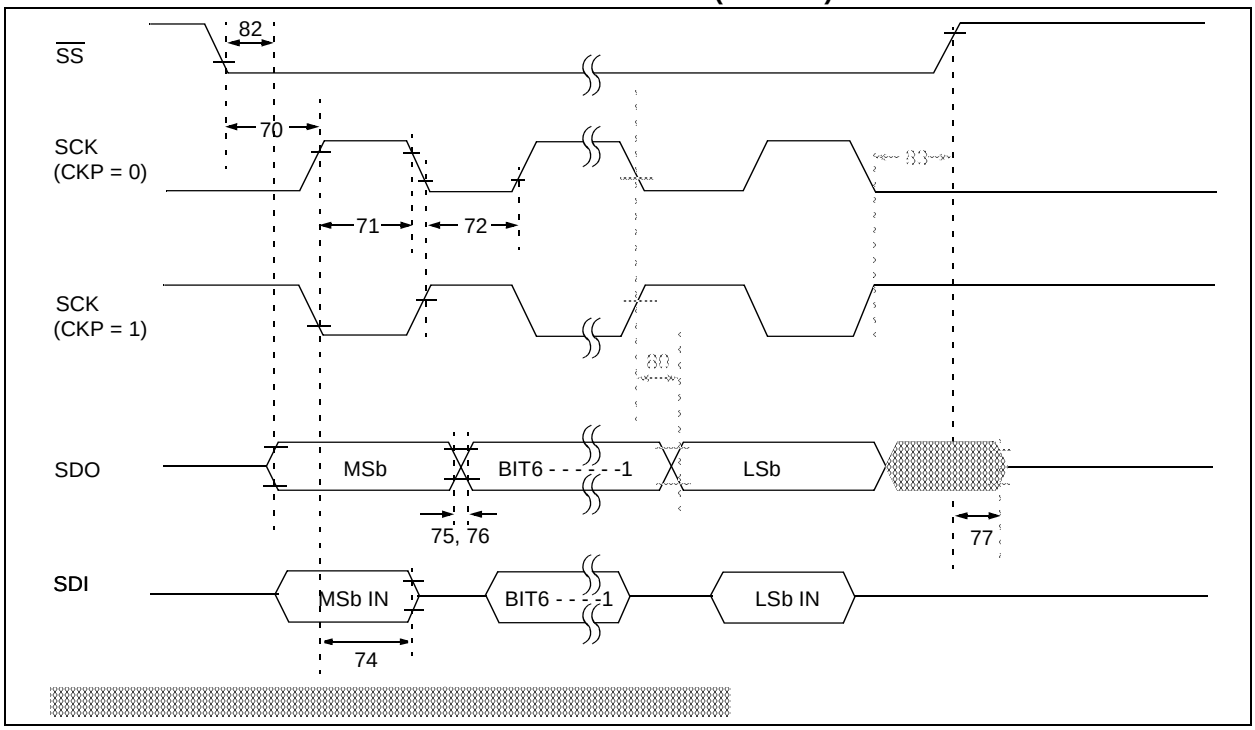


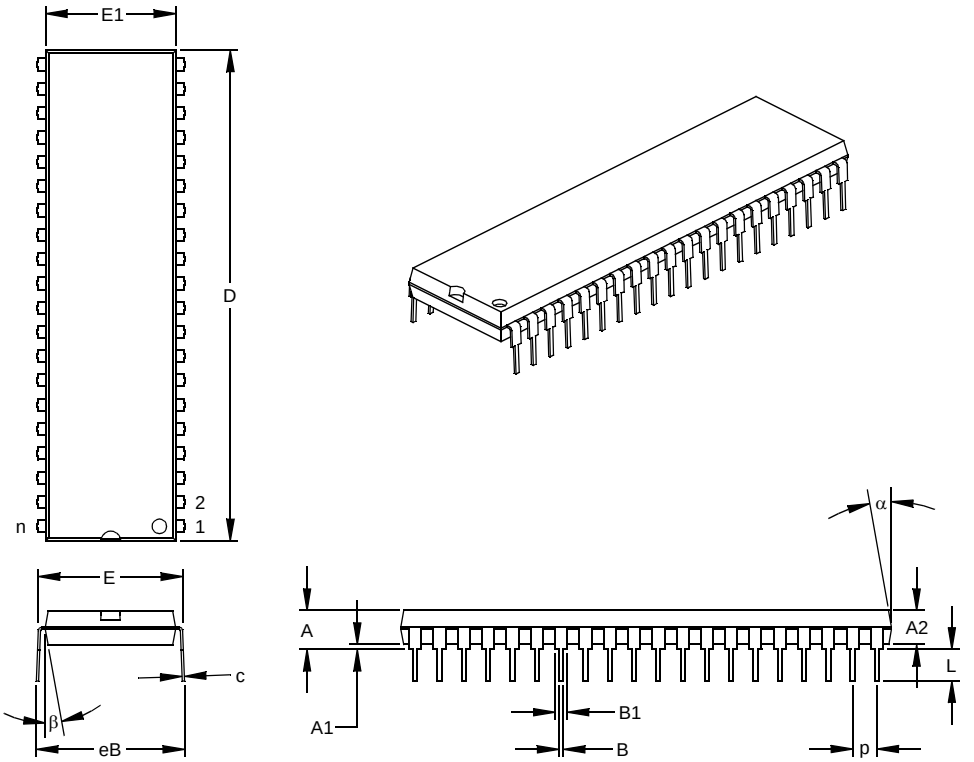
TABLE 21-14: EXAMPLE SPI SLAVE MODE REQUIREMENTS (CKE = 1)

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{SS}$↓ to SCK↓ or SCK↑ input		TCY	—	ns	
71	TscH	SCK input high time (Slave mode)	Continuous	1.25TCY + 30	—	ns	
71A			Single Byte	40	—	ns	**(Note 1)**
72	TscL	SCK input low time (Slave mode)	Continuous	1.25TCY + 30	—	ns	
72A			Single Byte	40	—	ns	**(Note 1)**
73A	TB2B	Last clock edge of Byte1 to the first clock edge of Byte2		1.5TCY + 40	—	ns	**(Note 2)**
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	—	ns	
75	TdoR	SDO data output rise time	PIC18**C**XXX	—	25	ns	
			PIC18**LC**XXX		45	ns	
76	TdoF	SDO data output fall time		—	25	ns	
77	TssH2doZ	$\overline{SS}$↑ to SDO output hi-impedance		10	50	ns	
78	TscR	SCK output rise time (Master mode)	PIC18**C**XXX	—	25	ns	
			PIC18**LC**XXX	—	45	ns	
79	TscF	SCK output fall time (Master mode)		—	25	ns	
80	TscH2doV, TscL2doV	SDO data output valid after SCK edge	PIC18**C**XXX	—	50	ns	
			PIC18**LC**XXX	—	100	ns	
82	TssL2doV	SDO data output valid after $\overline{SS}$↓ edge	PIC18**C**XXX	—	50	ns	
			PIC18**LC**XXX	—	100	ns	
83	TscH2ssH, TscL2ssH	$\overline{SS}$ ↑ after SCK edge		1.5TCY + 40	—	ns	

Note 1: Requires the use of Parameter # 73A.
2: Only if Parameter # 71A and # 72A are used.

40-Lead Plastic Dual In-line (P) – 600 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		40			40	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.160	.175	.190	4.06	4.45	4.83
Molded Package Thickness	A2	.140	.150	.160	3.56	3.81	4.06
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.595	.600	.625	15.11	15.24	15.88
Molded Package Width	E1	.530	.545	.560	13.46	13.84	14.22
Overall Length	D	2.045	2.058	2.065	51.94	52.26	52.45
Tip to Seating Plane	L	.120	.130	.135	3.05	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.030	.050	.070	0.76	1.27	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing §	eB	.620	.650	.680	15.75	16.51	17.27
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MO-011
Drawing No. C04-016

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PIC18CXX2 PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	–	X	/XX	XXX
Device		Temperature Range	Package	Pattern

Device	PIC18CXX2[1], PIC18CXX2T[2]; VDD range 4.2V to 5.5V PIC18LCXX2[1], PIC18LCXX2T[2]; VDD range 2.5V to 5.5V
Temperature Range	I = -40°C to +85°C (Industrial) E = -40°C to +125°C (Extended)
Package	JW = Windowed CERDIP[3] PT = TQFP (Thin Quad Flatpack) SO = SOIC SP = Skinny plastic dip P = PDIP L = PLCC
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise)

Examples:

a) PIC18LC452 - I/P 301 = Industrial temp., PDIP package, 4 MHz, Extended VDD limits, QTP pattern #301.

b) PIC18LC242 - I/SO = Industrial temp., SOIC package, Extended VDD limits.

c) PIC18C442 - E/P = Extended temp., PDIP package, 40MHz, normal VDD limits.

Note 1: C = Standard Voltage range
LC = Wide Voltage Range

2: T = in tape and reel - SOIC, PLCC, and TQFP packages only.

3: JW Devices are UV erasable and can be programmed to any device configuration. JW Devices meet the electrical requirement of each oscillator type (including LC devices).

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Data Sheets
Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office
2. The Microchip Worldwide Site (www.microchip.com)